

(12) United States Patent Chistyakov

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(54) HIGH DEPOSITION RATE SPUTTERING

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Assignee: Zond, Inc., Mansfield, MA (US)

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This patent is subject to a terminal dis-

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Field of Search 204/192.12, 192.13,

204/298.03, 298.06, 298.07, 298.08, 298.14, 298.19

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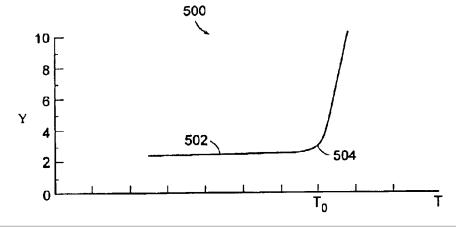
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(57)**ABSTRACT**

Methods and apparatus for high-deposition sputtering are described. A sputtering source includes an anode and a cathode assembly that is positioned adjacent to the anode. The cathode assembly includes a sputtering target. An ionization source generates a weakly-ionized plasma proximate to the anode and the cathode assembly. A power supply produces an electric field between the anode and the cathode assembly that creates a strongly-ionized plasma from the weakly-ionized plasma. The strongly-ionized plasma includes a first plurality of ions that impact the sputtering target to generate sufficient thermal energy in the sputtering target to cause a sputtering yield of the sputtering target to be non-linearly related to a temperature of the sputtering target.

40 Claims, 13 Drawing Sheets





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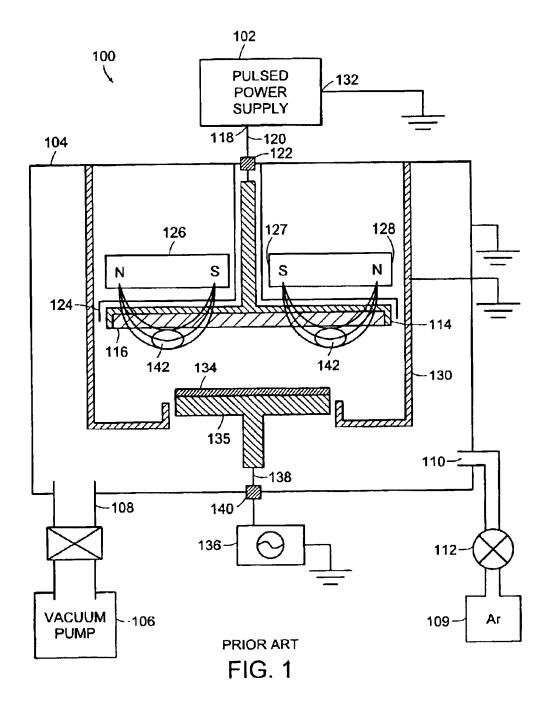
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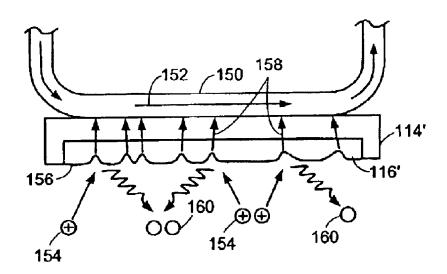


FIG. 2 PRIOR ART

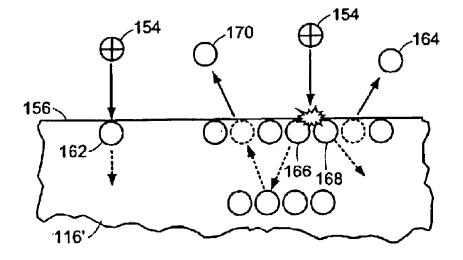
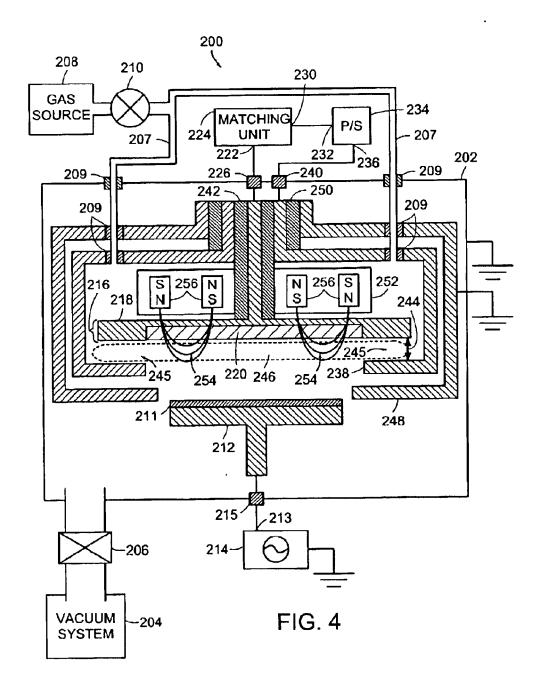


FIG. 3 PRIOR ART





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